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APPLIĆATION NO.	PLICATION NO. FILING DATE		FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/761,702 01		01/21/2004	Meng-Hung Chen	10113671	· 3361
34283	7590	12/12/2006		EXAMINER	
QUINTER			WARREN, MATTHEW E		
1617 BROADWAY, 3RD FLOOR SANTA MONICA, CA 90404				ART UNIT	PAPER NUMBER
				2815	
				DATE MAILED: 12/12/2000	DATE MAILED: 12/12/2006

Please find below and/or attached an Office communication concerning this application or proceeding.

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·		Application	No.	Applicant(s)	2			
	10/761,702		CHEN, MENG-HUN	1G				
Office Action Summary		Examiner		Art Unit				
		Matthew E. \		2815				
The MAILING DATE of thi Period for Reply	s communication app	ears on the c	over sheet with the c	orrespondence add	íress			
A SHORTENED STATUTORY IN WHICHEVER IS LONGER, FROM Extensions of time may be available under after SIX (6) MONTHS from the mailing date. If NO period for reply is specified above, the Failure to reply within the set or extended pany reply received by the Office later than earned patent term adjustment. See 37 Ci	DM THE MAILING DA the provisions of 37 CFR 1.13 the of this communication. the maximum statutory period we period for reply will, by statute, three months after the mailing	ATE OF THIS 36(a). In no event, will apply and will e , cause the applica	COMMUNICATION however, may a reply be tim xpire SIX (6) MONTHS from tion to become ABANDONEI	I. the mailing date of this cor (35 U.S.C. § 133).				
Status		•						
 Responsive to communication This action is FINAL. Since this application is in closed in accordance with 	2b)☐ This condition for allowar	action is nor	n-final. r formal matters, pro		merits is			
Disposition of Claims	,							
4) Claim(s) 1.3-7,9,27 and 2 4a) Of the above claim(s) 5) Claim(s) is/are allo 6) Claim(s) 1.3-7,9,27 and 2 7) Claim(s) is/are object 8) Claim(s) are subject 4 Application Papers 9) The specification is objected 10) The drawing(s) filed on	is/are withdrawwed. is/are rejected. ected to. t to restriction and/or ed to by the Examine	wn from cons r election req	ideration. uirement.	≣ xaminer.				
Applicant may not request the Replacement drawing sheet 11) The oath or declaration is	s) including the correct	ion is required	if the drawing(s) is obj	ected to. See 37 CF				
Priority under 35 U.S.C. § 119								
 12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f). a) All b) Some * c) None of: 1. Certified copies of the priority documents have been received. 2. Certified copies of the priority documents have been received in Application No 3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)). * See the attached detailed Office action for a list of the certified copies not received. 								
Attachment(s) 1) Notice of References Cited (PTO-892 2) Notice of Draftsperson's Patent Drawi 3) Information Disclosure Statement(s) (Paper No(s)/Mail Date	ng Review (PTO-948)	5) Interview Summary Paper No(s)/Mail Da) Notice of Informal P) Other:	ate	-152)			

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DETAILED ACTION

This Office Action is in response to the Amendment filed on September 30, 2006.

Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Claims 1, 3-7, 9, 27, and 28 are rejected under 35 U.S.C. 103(a) as being unpatentable over Liang et al. (US 6,368,952 B1) in view of Chiang et al. (US 5,817,572) and Liu et al. (US 6,284,642 B1).

In re claim 1, Liang et al. shows (fig. 6) a contact structure of a device, comprising; a substrate (10) having a transistor of the device thereon, the transistor having a raised gate electrode (16a), a drain region and a source region (18a, 18b); a composite dielectric layer, sequentially having a first dielectric layer (20a), barrier layer (26a), and second dielectric layer (28a), directly on the transistor, the first dielectric layer comprising polyimide (col. 6, lines 7-29) the composite dielectric layer having an opening exposing the drain region; and a tungsten (22a) or polysilicon layer filling the opening, wherein the thickness of the first dielectric layer (4000-7000 Å) (col. 6, lines 27-29) is thicker than the second dielectric layer (3000-5000 Å) (col. 9, lines 37-45). Liang shows all of the elements of the claims except the contact specifically being a bit line contact structure of a memory device. Liang discloses (col. 4, lines 27-45) that the

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invention pertains to FETs within semiconductor integrated circuits. It is well know that semiconductor FETs may be memory devices (such as DRAMs) that have bit line contact structures. However, Chiang et al. discloses (col. 7, lines 28-37 and col. 12, lines 44-52) that the an inventive contact structure can be used as a bit line contact. The contact is also formed in a memory device. Therefore, it would have been obvious to one of ordinary skill in the art at the time the invention was made to modify the device of Liang by using the contact structure as a bit line contact because Chiang teaches that memory devices employ bit line contacts.

Liang already shows that tungsten (22) fills a lower portion of the opening and copper fills the upper portion (32) of the opening. Liang and Chiang shows all of the elements of the claims except the tungsten or polysilicon layer filling the opening of the composite dielectric layer. Although Liang and Chiang do not explicitly show such a limitation, it is well known in the art that tungsten and polysilicon are known fill materials used for filling entire vias, plugs, and contact holes. Liu shows (fig. 5) a composite dielectric layer (12, 14, 16, 18) having a contact hole (38) filled with copper, polysilicon, or tungsten (42). Therefore, it would have been obvious to one of ordinary skill in the art at the time the invention was made to modify the contact structure of Liang and Chiang by filling the composite dielectric with tungsten or polysilicon because Liu teaches that such materials are suitable for filling an opening for a composite dielectric layer.

In re claims 3-7 and 9, Liang discloses that the first dielectric is 4000 Å thick, that the barrier layer (26) is SiN (col. 7, lines 60-63 and col. 8, lines 57-62), the barrier layer has a thickness of 300 Å (col. 9, lines 1-4), the second dielectric layer (28) comprises an

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oxide layer (col. 6, lines 7-29 and col. 9, lines 36-45), and that the second dielectric layer is 3000 Å thick (col. 9, lines 36-45). The tungsten layer (22) is 4000 Å because it has the same height as the first PMD layer (20).

In re claims 27 and 28, Liang discloses (col. 6, lines 7-29) that the polyimide is fluorinated (fluorinated polymer). The first dielectric layer is polysilsesquioxane because one of the dielectrics used is a silsesquioxane.

Response to Arguments

Applicant's arguments with respect to claims 1, 3-7, 9, 27, and 28 have been considered but are moot in view of the new ground(s) of rejection.

Conclusion

Applicant's amendment necessitated the new ground(s) of rejection presented in this Office action. Accordingly, **THIS ACTION IS MADE FINAL**. See MPEP § 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of

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the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the date of this final action.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Matthew E. Warren whose telephone number is (571) 272-1737. The examiner can normally be reached on Mon-Thur and alternating Fri 9:00-5:00pm.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Kenneth Parker can be reached on (571) 272-2298. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

MEW

December 9, 2006

KENNETH PARKER
SUPERVISORY PATENT EXAMINES